## **MA3S781FG**

### Silicon epitaxial planar type

For high speed switching circuits For wave detection

#### ■ Features

- Optimum for high-density mounting
- $\bullet$  Short reverse recovery time  $t_{\rm rr}$  , optimum for high-frequency rectification

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Reverse voltage	V <sub>R</sub>	30	V		
Maximum peak reverse voltage		V <sub>RM</sub>	30	V	
Forward current	Single	T	30	mA	
	Series	$I_{\mathrm{F}}$	20		
Peak forward current	Single	7	150	mA	
	Series	$I_{FM}$	110		
Junction temperature		$T_{j}$	125	°C	
Storage temperature		T <sub>stg</sub>	-55 to +125	°C	

#### ■ Package

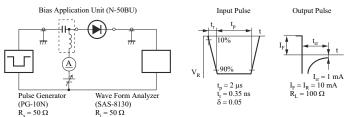
- Code
  - SSMini3-F3
- Pin Name
  - 1: Anode 1
  - 2: Cathode 2
  - 3: Cathode 1
  - Anode 2
- Marking Symbol: M1U
- Internal Connection



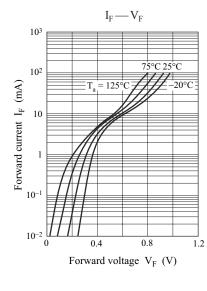
#### ■ Electrical Characteristics $T_a = 25$ °C±3°C

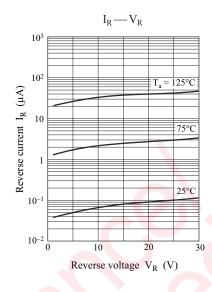
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F1}$	$I_F = 1 \text{ mA}$	60		0.4	V
	$V_{F2}$	$I_F = 30 \text{ mA}$			1.0	
Reverse current	$I_R$	$V_R = 30 \text{ V}$			300	nA
Terminal capacitance	$C_{t}$	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	t <sub>rr</sub>	$\begin{aligned} I_F = I_R = 10 \text{ mA}, I_{rr} = 1 \text{ mA} \\ R_L = 100 \Omega \end{aligned}$		1.0		ns
Detection efficiency	η	$V_{IN} = 3 V_{(peak)}$ , f = 30 MHz R <sub>L</sub> = 3.9 k $\Omega$ , C <sub>L</sub> = 10 pF		65		%

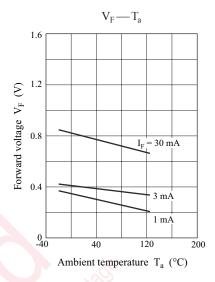
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. Absolute frequency of input and output is 2000 MHz
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. \*: t<sub>rr</sub> measurement circuit

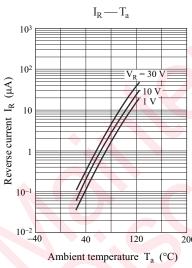


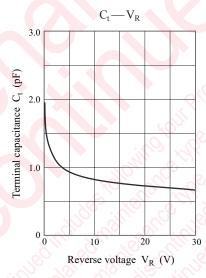
MA3S781FG Panasonic

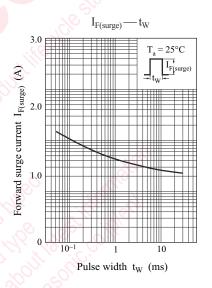


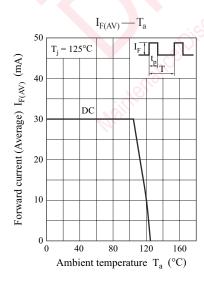






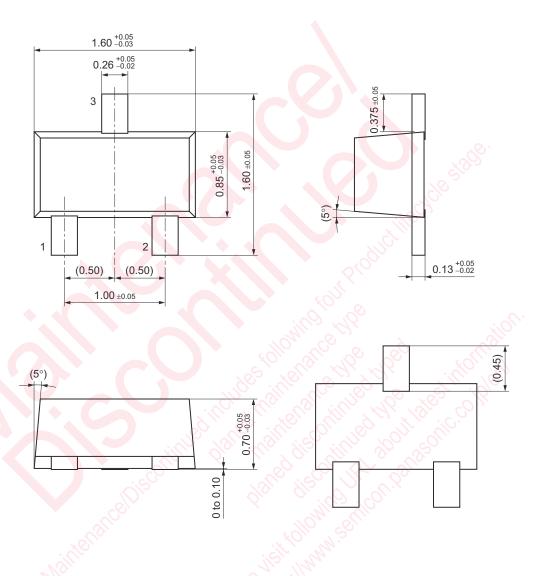






Panasonic MA3S781FG

SSMini3-F3 Unit: mm



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